



Product Change Notification

Change Notification #: 116526 - 00
Change Title: Intel® Server System R1304WFTYS,
PCN 116526-00, Product Design,
Update BIOS/BMC/ME/FRUSDR
Include Power Cable and Bracket for Optical
drive support in Accessory kit Firmware
Date of Publication: October 04, 2018

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	October 25, 2018
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Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Systems R1304WFTYS:

1. Update BIOS revision from R00.01.0009 to R00.01.5013
2. Update the Manageability Engine (ME) firmware revision from 04.00.04.288 to 04.00.04.294
3. Update the Baseboard Management Controller (BMC) firmware revision from 1.29.7d703f59 to 1.43.627d127a
4. Update the FRUSDR revision from 1.29 to 1.43.

Intel Server Boards with factory firmware will display the following message on each boot until the BIOS is updated:

"WARNING: This Server is running factory firmware. A software update is required. As part of your system integration process, please load the latest system update package (SUP) to enable the latest security, quality and performance."

Intel is also including new power cable and bracket for Optical drive support in accessory kit.

Customer Impact of Change and Recommended Action:

The primary value of this factory BIOS is that it allows the customer to perform a single BIOS programming (upgrade or downgrade) without the requirement of moving the BIOS Recovery physical jumper. Once the first programming is done, any subsequent attempts to downgrade to a previous BIOS version will require moving the BIOS Recovery physical jumper.

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <https://www.intel.com/support/>

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Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre TA#	Pre PBA#	Post TA#	Post PBA#
R1304WFTYS	952625	H97411-009	H48104-852 H48104-862	H97411-010	H48104-853 H48104-863

PCN Revision History:

Date of Revision:

October 4, 2018

Revision Number:

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Reason:

Originally Published PCN



Product Change Notification

116526 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

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